## TSG-RAN Meeting \#8

 RP-000297Düsseldorf, Germany, 21-23 June 2000
Agenda Item: 6

Source: CWTS
To:
TSG-RAN \#8
Title: Work Item Description "Low chip rate TDD UTRAN architecture aspects"
Document for: Approval

## Work Item Description

## Title

Low chip rate TDD UTRAN architecture aspects

## 1 3GPP Work Area

| $\mathbf{X}$ | Radio Access |
| :--- | :--- |
|  | Core Network |
|  | Services |

## 2 Linked work items

Low Chip Rate TDD physical layer
Low chip rate TDD layer2 and layer3 protocol aspects
Smart Antenna
RF Radio Transmission/Reception, System Performance Requirements and Conformance Testing
Low chip rate TDD UE capabilities

## 3 Justification

The integration of TDD low chip rate option in Release 2000 was discussed and approved in RAN\#6. The work plan of the integration of low chip rate TDD in R00 was discussed in RAN\#7. As a feature, the low chip rate TDD is sub-divided into several building blocks. This paper is to describe one of the low chip rate TDD building blocks - UTRAN architecture aspects.

## 4 Objective

- For UTRAN architecture aspects, it includes the following work tasks:
- Iub aspects
- Iur aspects

| Task | Planned Start | Planned Finish |
| :--- | :--- | :--- |
| prepare technical inputs | $06 / 2000$ | $09 / 2000$ |
| drafting CR's and possible new specs | $09 / 2000$ | $12 / 2000$ |

## 5 Service Aspects

None
6 MMI-Aspects
None

## $7 \quad$ Charging Aspects

None
8
Security Aspects
None

| Affects <br> $:$ | USIM | ME | AN | CN | Others |
| :--- | :--- | :--- | :--- | :--- | :--- |
| Yes |  |  | X |  |  |
| No | X | X |  | X | X |
| Don't <br> know |  |  |  |  |  |

10
Expected Output and Time scale (to be updated at each plenary)


11 Work item raporteurs
Mr. Yanhui Liu (CATT/CWTS)

12 Work item leadership
RAN WG3
13 Supporting Companies

14 Classification of the WI (if known)

|  | Feature (go to 14a) |
| :--- | :--- |
| X | Building Block (go to 14b) |
|  | Work Task (go to 14 c ) |

14a The WI is a Feature: List of building blocks under this feature
(list of Work Items identified as building blocks)
The building blocks should be discussed and approved via email discussion

14b The WI is a Building Block: parent Feature
(one Work Item identified as a feature)
low chip rate TDD
14c The WI is a Work Task: parent Building Block
(one Work Item identified as a building block)

